

## SIPMOS<sup>®</sup> Power Transistor

- N channel
- Enhancement mode
- Avalanche-rated
- Pb-free lead plating; RoHS compliant
- . Halogen-free according to IEC61249-2-21





2 (tab)		
		3
Pin 1	Pin 2	Pin 3

Туре	V <sub>DS</sub>	I <sub>D</sub>	R <sub>DS(on)</sub>	Package	Pb-free
BUZ 30AH3045A	200 V	21 A	0.13 Ω	PG-TO263-3	Yes

#### Maximum Ratings

Parameter	Symbol	Values	Unit
Continuous drain current	I <sub>D</sub>		A
$T_{\rm C} = 26 ^{\circ}{\rm C}$		21	
Pulsed drain current	I <sub>Dpuls</sub>		
<i>T</i> <sub>C</sub> = 25 °C		84	
Avalanche current,limited by $T_{jmax}$	/ <sub>AR</sub>	21	
Avalanche energy, periodic limited by $T_{jmax}$	EAR	12	mJ
Avalanche energy, single pulse	E <sub>AS</sub>		
$I_{\rm D}$ = 21 A, $V_{\rm DD}$ = 50 V, $R_{\rm GS}$ = 25 $\Omega$			
<i>L</i> = 1.53 mH, <i>T</i> <sub>j</sub> = 25 °C		450	
Gate source voltage	V <sub>GS</sub>	± 20	V
Power dissipation	Ptot		W
$T_{\rm C} = 25 ^{\circ}{\rm C}$		125	
Operating temperature	Tj	-55 + 150	°C
Storage temperature	T <sub>stg</sub>	-55 + 150	
Thermal resistance, chip case	R <sub>thJC</sub>	≤ 1	K/W
Thermal resistance, chip to ambient	R <sub>thJA</sub>	75	
DIN humidity category, DIN 40 040		E	
IEC climatic category, DIN IEC 68-1		55 / 150 / 56	



## Electrical Characteristics, at $T_j$ = 25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	120 214
Static Characteristics					
Drain- source breakdown voltage	V <sub>(BR)DSS</sub>		U.		V
$V_{\rm GS}$ = 0 V, $I_{\rm D}$ = 0.25 mA, $T_{\rm j}$ = 25 °C		200	=	-	
Gate threshold voltage	V <sub>GS(th)</sub>			5	
V <sub>GS</sub> =V <sub>DS,</sub> <i>I</i> <sub>D</sub> = 1 mA		2.1	3	4	18
Zero gate voltage drain current	I <sub>DSS</sub>				μA
$V_{\rm DS}$ = 200 V, $V_{\rm GS}$ = 0 V, $T_{\rm j}$ = 25 °C		-2	0.1	1	
$V_{\text{DS}} = 200 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_{\text{j}} = 125 \text{ °C}$		-	10	100	
Gate-source leakage current	IGSS				nA
$V_{\rm GS} = 20 \text{ V}, \ V_{\rm DS} = 0 \text{ V}$		<del>1</del> 1	10	100	
Drain-Source on-resistance	R <sub>DS(on)</sub>				Ω
V <sub>GS</sub> = 10 V, <i>I</i> <sub>D</sub> = 13.5 A		-	0.1	0.13	



# Electrical Characteristics, at $\mathcal{T}_{j}$ = 25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Dynamic Characteristics					
Transconductance	g <sub>fs</sub>				s
$V_{\rm DS} \ge 2 * I_{\rm D} * R_{\rm DS(on)max}$ , $I_{\rm D} = 13.5 \rm A$		6	15	17	
Input capacitance	Ciss			0	pF
$V_{\rm GS}$ = 0 V, $V_{\rm DS}$ = 25 V, f = 1 MHz		<u></u>	1400	1900	
Output capacitance	Coss				
$V_{\rm GS}$ = 0 V, $V_{\rm DS}$ = 25 V, f = 1 MHz		<del></del>	280	400	
Reverse transfer capacitance	C <sub>rss</sub>				
$V_{\rm GS}$ = 0 V, $V_{\rm DS}$ = 25 V, f = 1 MHz		-	130	200	
Turn-on delay time	t <sub>d(on)</sub>				ns
$V_{\rm DD}$ = 30 V, $V_{\rm GS}$ = 10 V, $I_{\rm D}$ = 3 A	12/ 52.				
$R_{\rm GS} = 50 \ \Omega$		12	30	45	
Rise time	t <sub>r</sub>	7	Υ.		
$V_{\text{DD}} = 30 \text{ V}, V_{\text{GS}} = 10 \text{ V}, I_{\text{D}} = 3 \text{ A}$					
$R_{\rm GS} = 50 \ \Omega$			70	110	
Turn-off delay time	td(off)				
$V_{\rm DD}$ = 30 V, $V_{\rm GS}$ = 10 V, $I_{\rm D}$ = 3 A					
$R_{\rm GS} = 50 \ \Omega$		-	250	320	
Fall time	<i>t</i> f				
$V_{\rm DD}$ = 30 V, $V_{\rm GS}$ = 10 V, $I_{\rm D}$ = 3 A					
$R_{\rm GS} = 50 \ \Omega$		=	90	120	



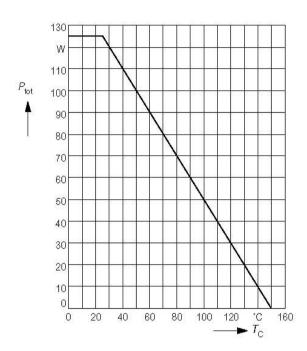
Parameter	Symbol	Values			Unit
	c	min.	typ.	max.	
Reverse Diode					
Inverse diode continuous forward current	I <sub>S</sub>				A
$T_{\rm C} = 25 ^{\circ}{\rm C}$		-	-	21	
Inverse diode direct current,pulsed	/ <sub>SM</sub>				
$T_{\rm C} = 25 \ ^{\circ}{\rm C}$		-	-	84	
Inverse diode forward voltage	V <sub>SD</sub>			.5	V
$V_{\rm GS}$ = 0 V, $I_{\rm F}$ = 42 A		2	1.2	1.6	
Reverse recovery time	t <sub>rr</sub>	7	7		ns
$V_{\rm R}$ = 100 V, $I_{\rm F}$ = $I_{\rm S}$ , $di_{\rm F}/dt$ = 100 A/µs		<u>22</u>	180	-	
Reverse recovery charge	Q <sub>rr</sub>				μC
V <sub>R</sub> = 100 V, <i>I</i> <sub>F</sub> = <i>I</i> <sub>S,</sub> d <i>i</i> <sub>F</sub> /d <i>t</i> = 100 A/μs		-	1.2	-	

## Electrical Characteristics, at $T_j$ = 25°C, unless otherwise specified



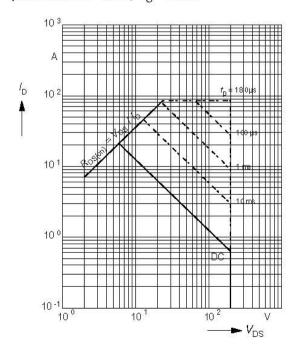
#### **Power dissipation**

 $P_{\text{tot}} = f(T_{\text{C}})$ 



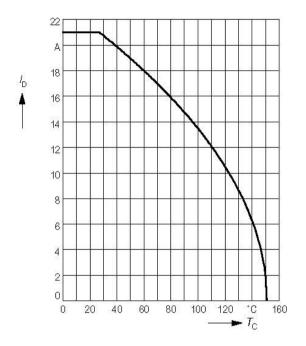
### Safe operating area

 $I_{\rm D}$  =  $f(V_{\rm DS})$ parameter: D = 0.01,  $T_{\rm C}$  = 25°C



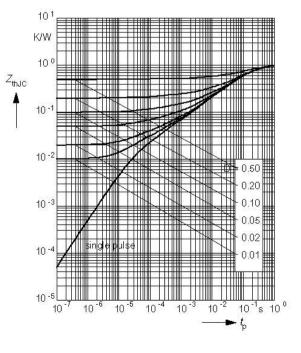
Drain current

 $I_{\rm D} = f(T_{\rm C})$ parameter:  $V_{\rm GS} \ge 10$  V



# Transient thermal impedance $Z_{\text{th JC}} = f(t_{\text{p}})$

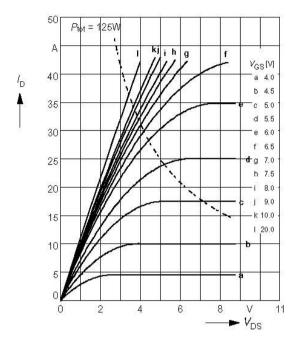
parameter:  $D = t_p / T$ 



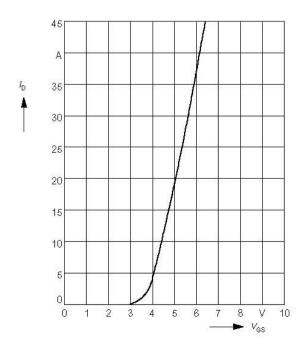


#### Typ. output characteristics

 $l_{\rm D}$  =  $f(V_{\rm DS})$ parameter:  $t_{\rm p}$  = 80 µs

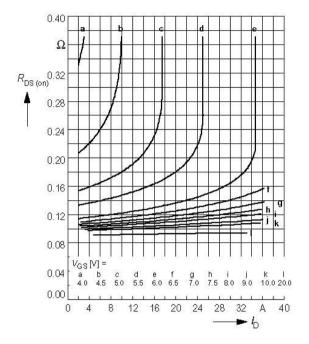


Typ. transfer characteristics  $l_D = f(V_{GS})$ parameter:  $t_p = 80 \ \mu s$  $V_{DS} \ge 2 \ x \ l_D \ x \ R_{DS}(on) \ max$ 



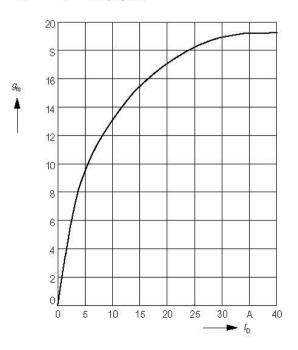
#### Typ. drain-source on-resistance

 $R_{\text{DS (on)}} = f(I_{\text{D}})$ parameter:  $V_{\text{GS}}$ 



#### Typ. forward transconductance $g_{fs} = f(I_D)$

parameter: *t*<sub>p</sub> = 80 µs, V<sub>DS</sub>≥2 x *I*<sub>D</sub> *x R*<sub>DS(on)max</sub>

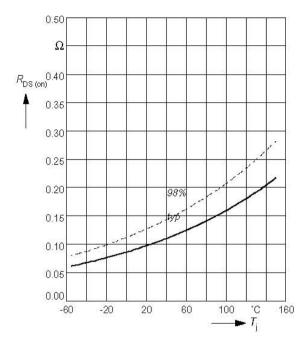


Rev 2.2



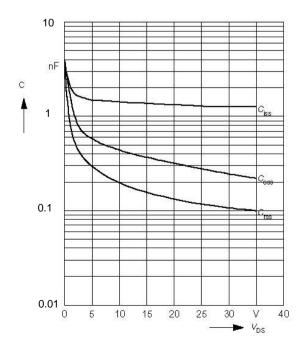
#### Drain-source on-resistance

 $R_{\text{DS (on)}} = f(T_j)$ parameter:  $I_{\text{D}} = 13.5 \text{ A}, V_{\text{GS}} = 10 \text{ V}$ 



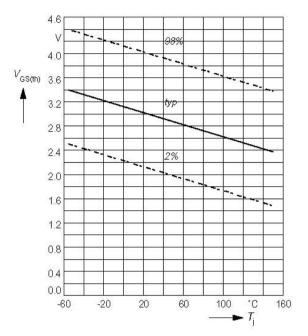
#### Typ. capacitances

 $C = f(V_{DS})$ parameter:  $V_{GS} = 0V$ , f = 1MHz



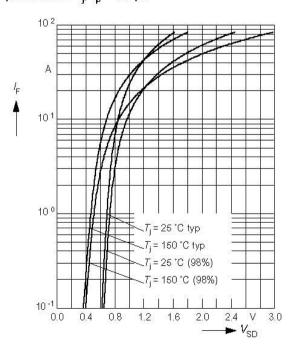
#### Gate threshold voltage

 $V_{\text{GS (th)}} = f(T_j)$ parameter:  $V_{\text{GS}} = V_{\text{DS}}$ ,  $I_{\text{D}} = 1$  mA



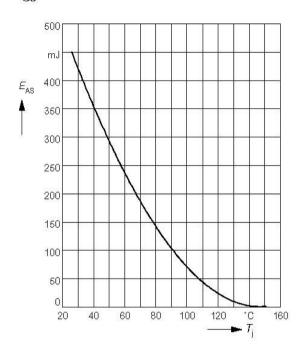
#### Forward characteristics of reverse diode

 $I_{\rm F} = f(V_{\rm SD})$ parameter:  $T_{\rm j}$ ,  $t_{\rm p} = 80~\mu {\rm s}$ 



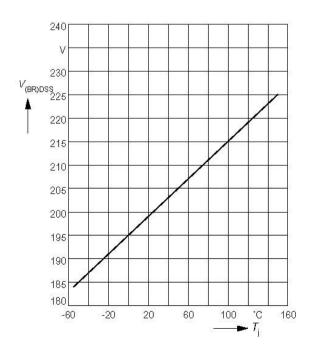


Avalanche energy  $E_{AS} = f(T_j)$ parameter:  $I_D = 21$  A,  $V_{DD} = 50$  V  $R_{GS} = 25 \Omega$ , L = 1.53 mH



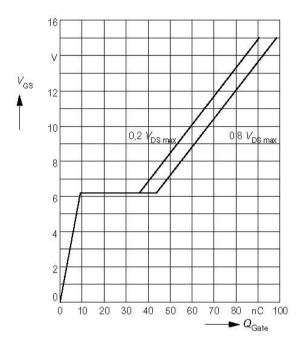
Drain-source breakdown voltage

 $V_{(BR)DSS} = f(T_j)$ 



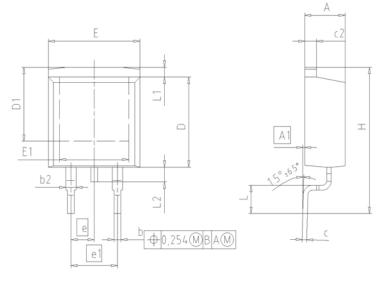
Typ. gate charge

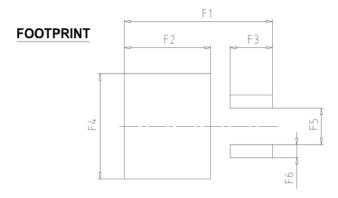
 $V_{GS} = f(Q_{Gate})$ parameter:  $I_{D puls} = 32 \text{ A}$ 



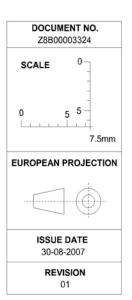


## Package Drawing: PG-TO263-3





DIM	MILLIM	ETERS	INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	4.30	4.57	0.169	0.180		
A1	0.00	0.25	0.000	0.010		
b	0.65	0.85	0.026	0.033		
b2	0.95	1.15	0.037	0.045		
С	0.33	0.65	0.013	0.026		
c2	1.17	1.40	0.046	0.055		
D	8.51	9.45	0.335	0.372		
D1	7.10	7.90	0.280	0.311		
E	9.80	10.31	0.386	0.406		
E1	6.50	8.60	0.256	0.339		
e	2.54		0.100			
e1	5.0	5.08		0.200		
N		2	2			
н	14.61	15.88	0.575	0.625		
L	2.29	3.00	0.090	0.118		
L1	0.70	1.60	0.028	0.063		
L2	1.00	1.78	0.039	0.070		
F1	16.05	16.25	0.632	0.640		
F2	9.30	9.50	0.366	0.374		
F3	4.50	4.70	0.177	0.185		
F4	10.70	10.90	0.421	0.429		
F5	3.65	3.85	0.144	0.152		
F6	1.25	1.45	0.049	0.057		





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